

Description

The VSM30P03 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

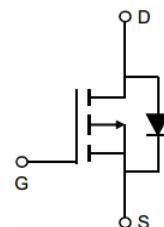
- $V_{DS} = -30V, I_D = -30A$
- $R_{DS(ON)} < 8.5m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} < 17m\Omega @ V_{GS} = -4.5V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- High side switch for full bridge converter
- DC/DC converter for LCD display



TO-220F



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM30P03-TF	VSM30P03	TO-220F	-	-	-

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	-30	A
Drain Current-Continuous($T_C=100^\circ C$)	$I_D(100^\circ C)$	-21.2	A
Drain Current-Pulsed ^(Note 1)	I_{DM}	-120	A
Maximum Power Dissipation	P_D	40	W
Single pulse avalanche energy ^(Note 5)	E_{AS}	380	mJ
Derating factor		0.27	W/ $^\circ C$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^\circ C$

Thermal Characteristic

Thermal Resistance,Junction-to- Case ^(Note 2)	$R_{\theta JC}$	3.75	$^\circ C/W$
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Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{D}}=-250\mu\text{A}$	-30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=-30\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	-1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	±100	nA
On Characteristics <small>(Note 3)</small>						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{D}}=-250\mu\text{A}$	-1.0	-1.5	-2.0	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_{\text{D}}=-15\text{A}$	-	6.7	8.5	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_{\text{D}}=-15\text{A}$	-	9.5	17	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_{\text{D}}=-15\text{A}$	-	30	-	S
Dynamic Characteristics <small>(Note 4)</small>						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=-15\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1.0\text{MHz}$	-	3736	-	PF
Output Capacitance	C_{oss}		-	485	-	PF
Reverse Transfer Capacitance	C_{rss}		-	439	-	PF
Switching Characteristics <small>(Note 4)</small>						
Turn-on Delay Time	$\text{t}_{\text{d(on)}}$	$\text{V}_{\text{DD}}=-15\text{V}, \text{I}_{\text{D}}=-15\text{A}, \text{V}_{\text{GS}}=-10\text{V}, \text{R}_{\text{GEN}}=3\Omega$	-	16	-	nS
Turn-on Rise Time	t_r		-	12	-	nS
Turn-Off Delay Time	$\text{t}_{\text{d(off)}}$		-	46	-	nS
Turn-Off Fall Time	t_f		-	22	-	nS
Total Gate Charge	Q_{g}	$\text{V}_{\text{DS}}=-15\text{V}, \text{I}_{\text{D}}=-15\text{A}, \text{V}_{\text{GS}}=-10\text{V}$	-	70.7	-	nC
Gate-Source Charge	Q_{gs}		-	8	-	nC
Gate-Drain Charge	Q_{gd}		-	17.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <small>(Note 3)</small>	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{S}}=-15\text{A}$	-	-	-1.2	V

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. E_{AS} condition: $\text{T}_j=25^\circ\text{C}, \text{V}_{\text{DD}}=-15\text{V}, \text{V}_{\text{G}}=-10\text{V}, \text{L}=0.5\text{mH}, \text{R}_g=25\Omega$

Typical Electrical and Thermal Characteristics (Curves)

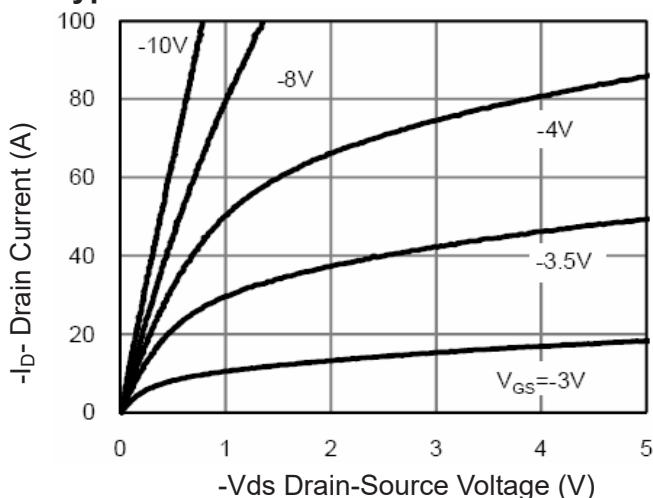


Figure 1 Output Characteristics

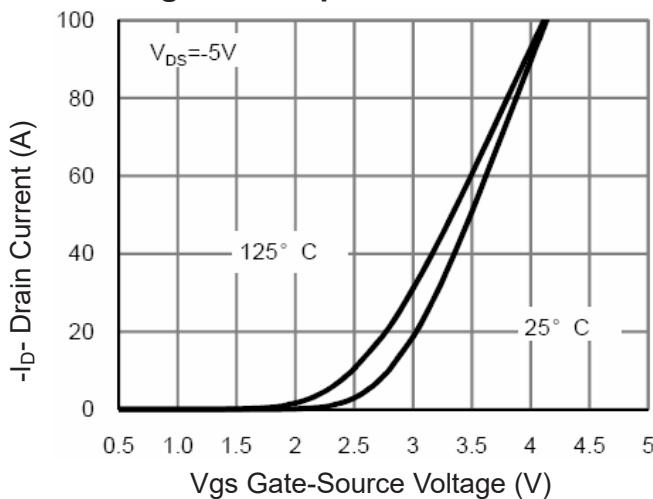


Figure 2 Transfer Characteristics

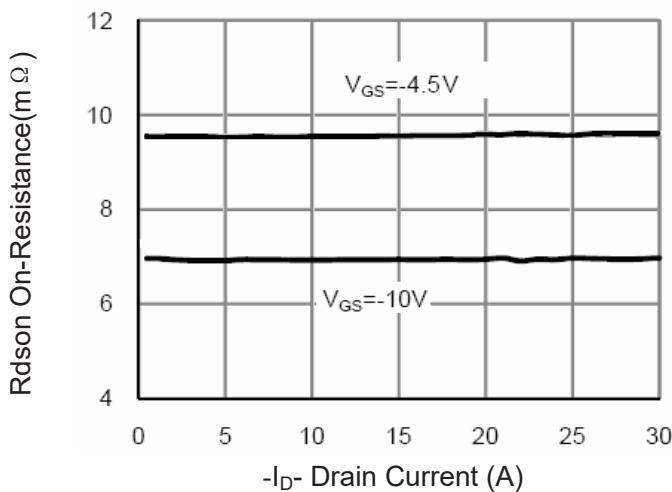


Figure 3 Rdson- Drain Current

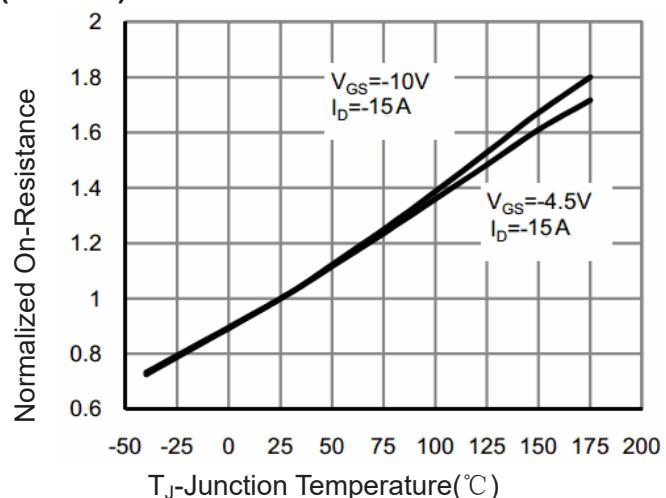


Figure 4 Rdson-Junction Temperature

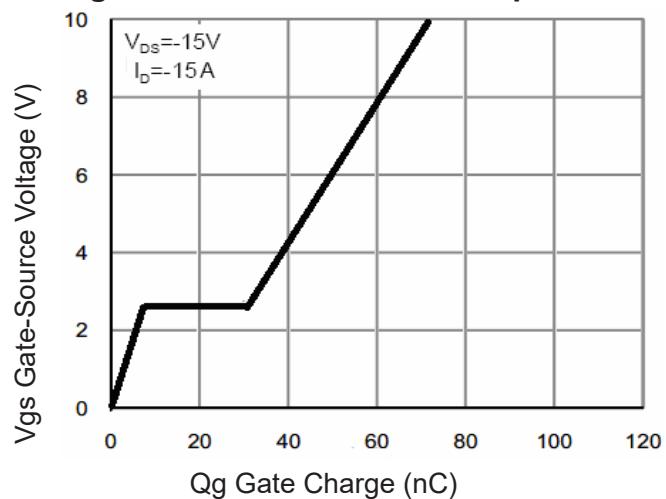


Figure 5 Gate Charge

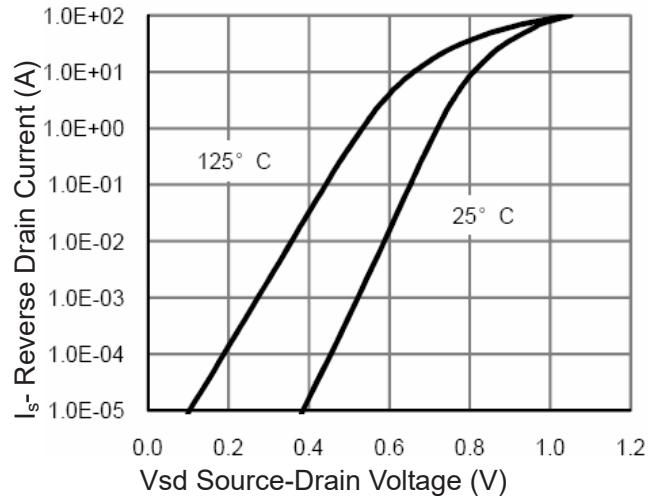
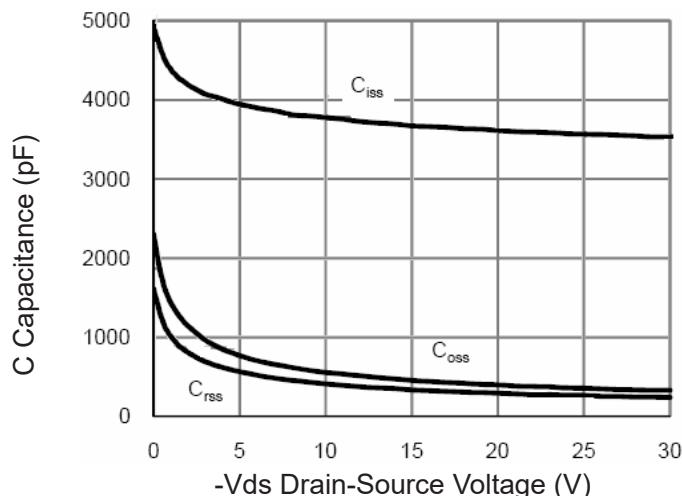
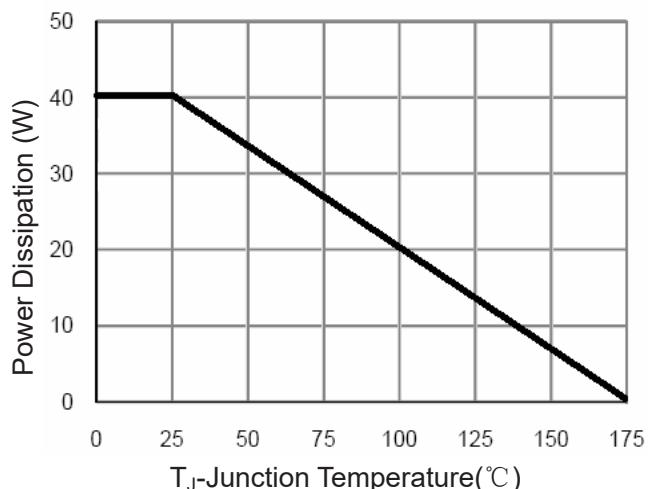
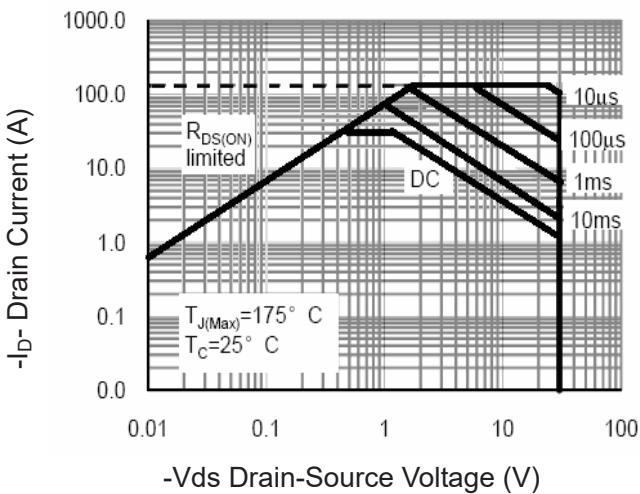
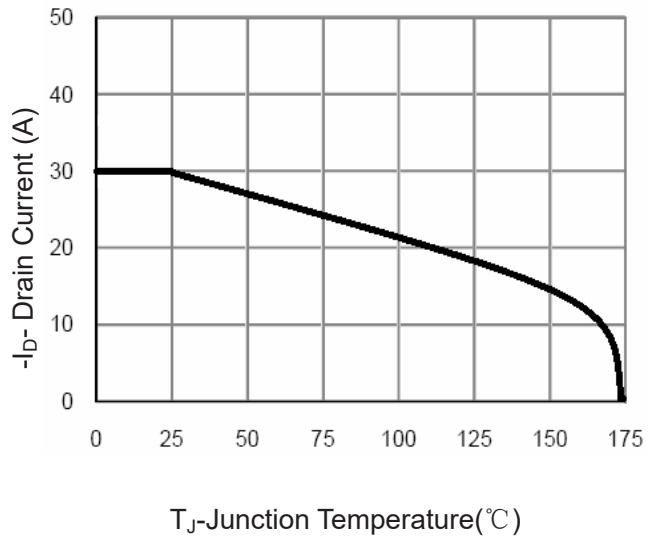
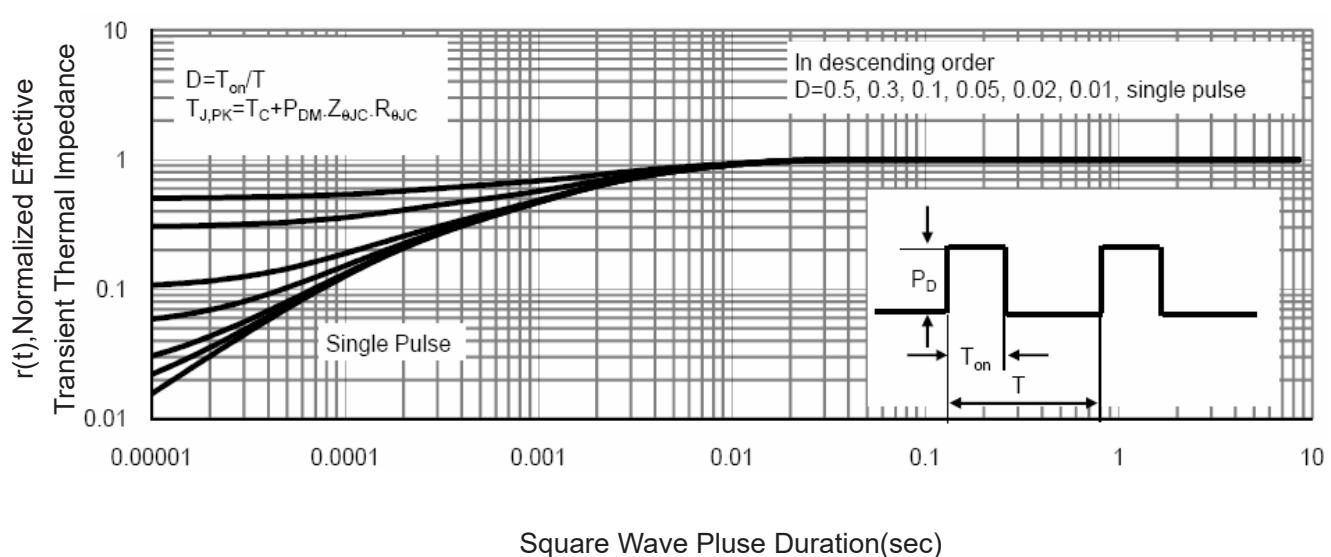


Figure 6 Source- Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating

Figure 8 Safe Operation Area

Figure 10 ID Current Derating

Figure 11 Normalized Maximum Transient Thermal Impedance